

# Laser Micromachining

One Stop Solution for Laser Micro Machining



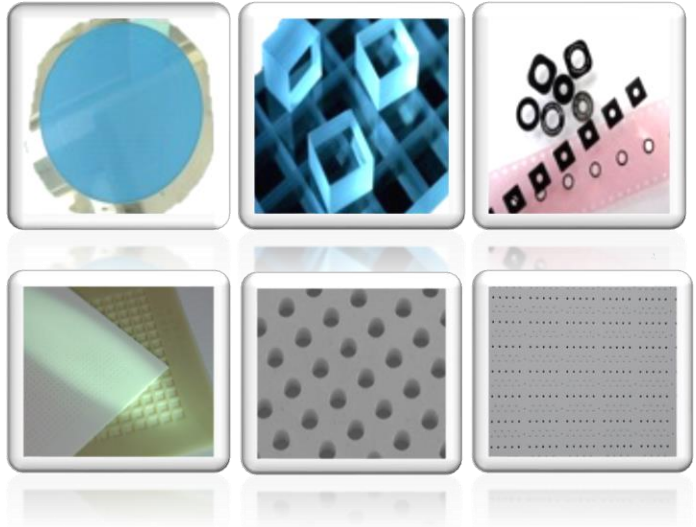
## ➤ Job shop Services

Machinable Material Categories:

- >Optical Glass & Quartz
- >Diamonds and Sapphire
- >Silicon & SiC
- >Ceramics
- >Polymers and PI ( Kapton )
- >Metals
- >Cutting-Edge Advanced Materials

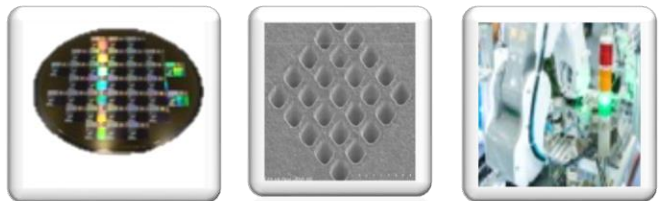
Job shop ability:

- >Laser Slicing:  
t 0.03~ 5.0 mm
- >Laser Drilling  
t 0.1~ 5.0 mm  
φ 0.3~40.0mm



## ➤ Field-Proven Customized Laser Systems

- >Semi conductor / Probe card Drilling Technology
- >3D glass bending technology
- >3D WLP glass wafer processing
- >Laser Lift-Off (LLO)
- >Micro-fluidics
- >Optics slicing system
- >Laser micro drilling system
- >Laser glass polishing system
- >Glass wafer processing system



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